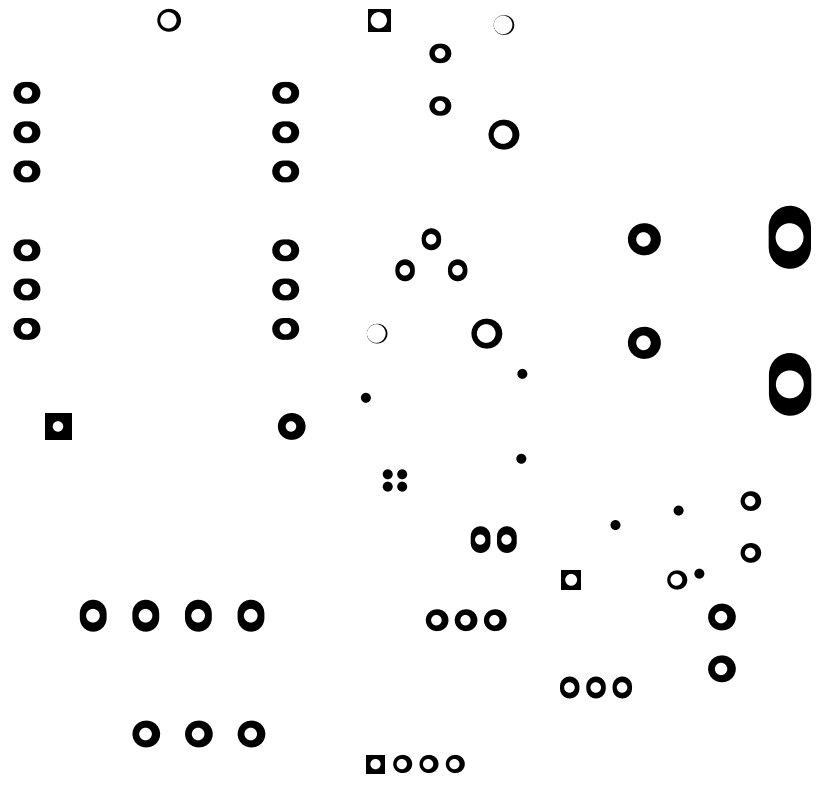
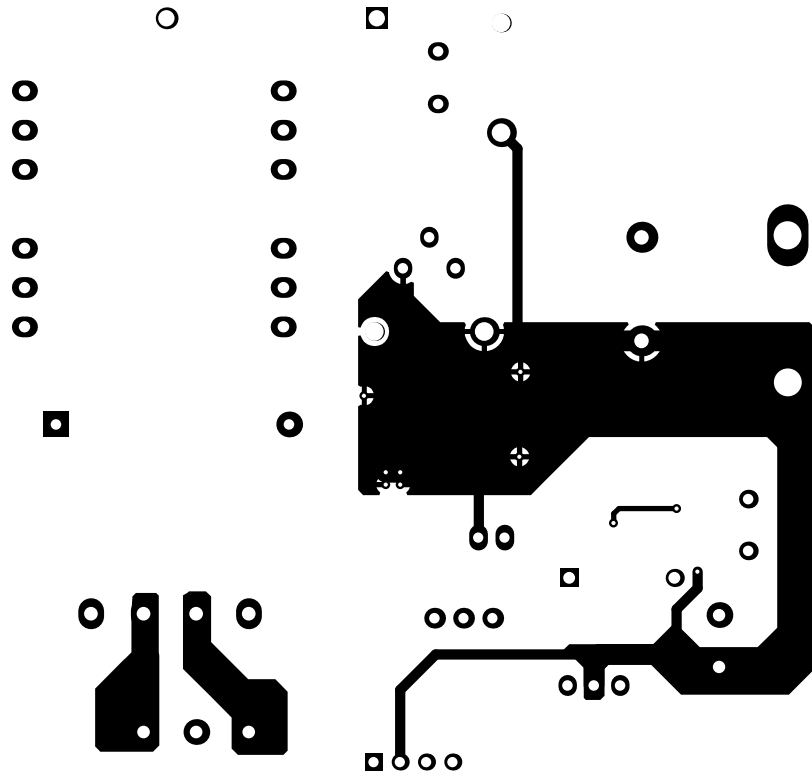


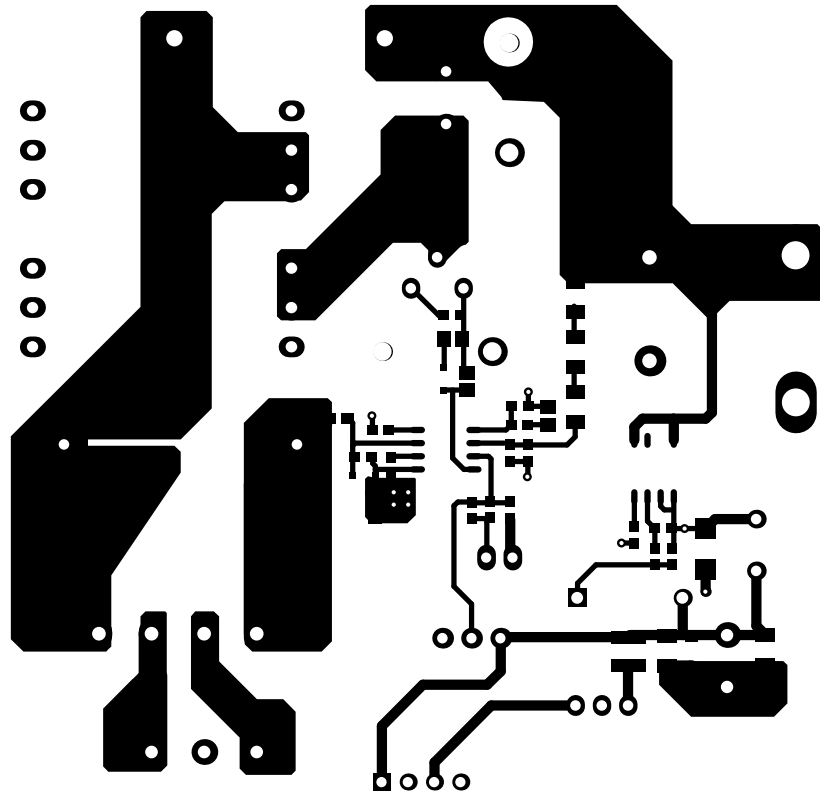
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00776		
PLOT NAME = Top Overlay	GENERATED : 11/17/2016 15:31:12		TEXAS INSTRUMENTS



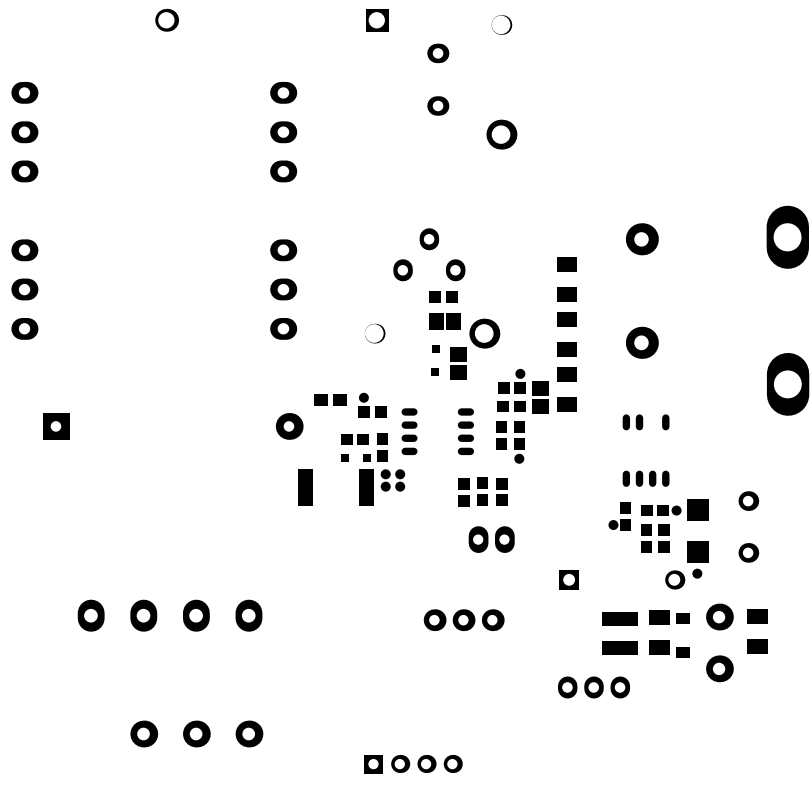
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00776		
PLOT NAME = Top Solder Mask	GENERATED : 11/17/2016 15:31:12		TEXAS INSTRUMENTS



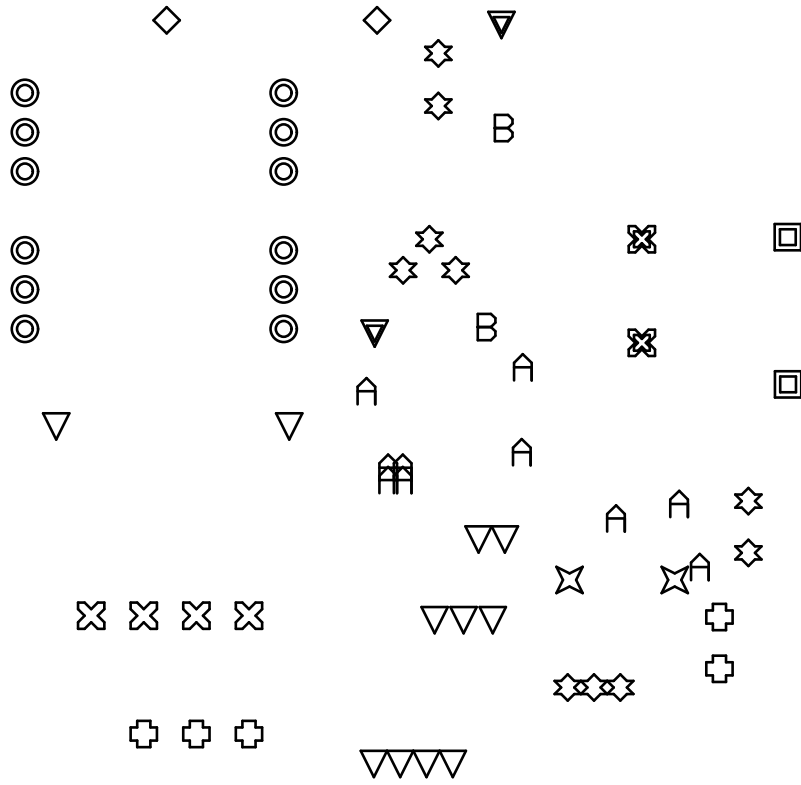
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00776		
PLOT NAME = Top Layer	GENERATED : 11/17/2016 15:31:13		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00776		
PLOT NAME = Bottom Layer	GENERATED : 11/17/2016 15:31:14		TEXAS INSTRUMENTS

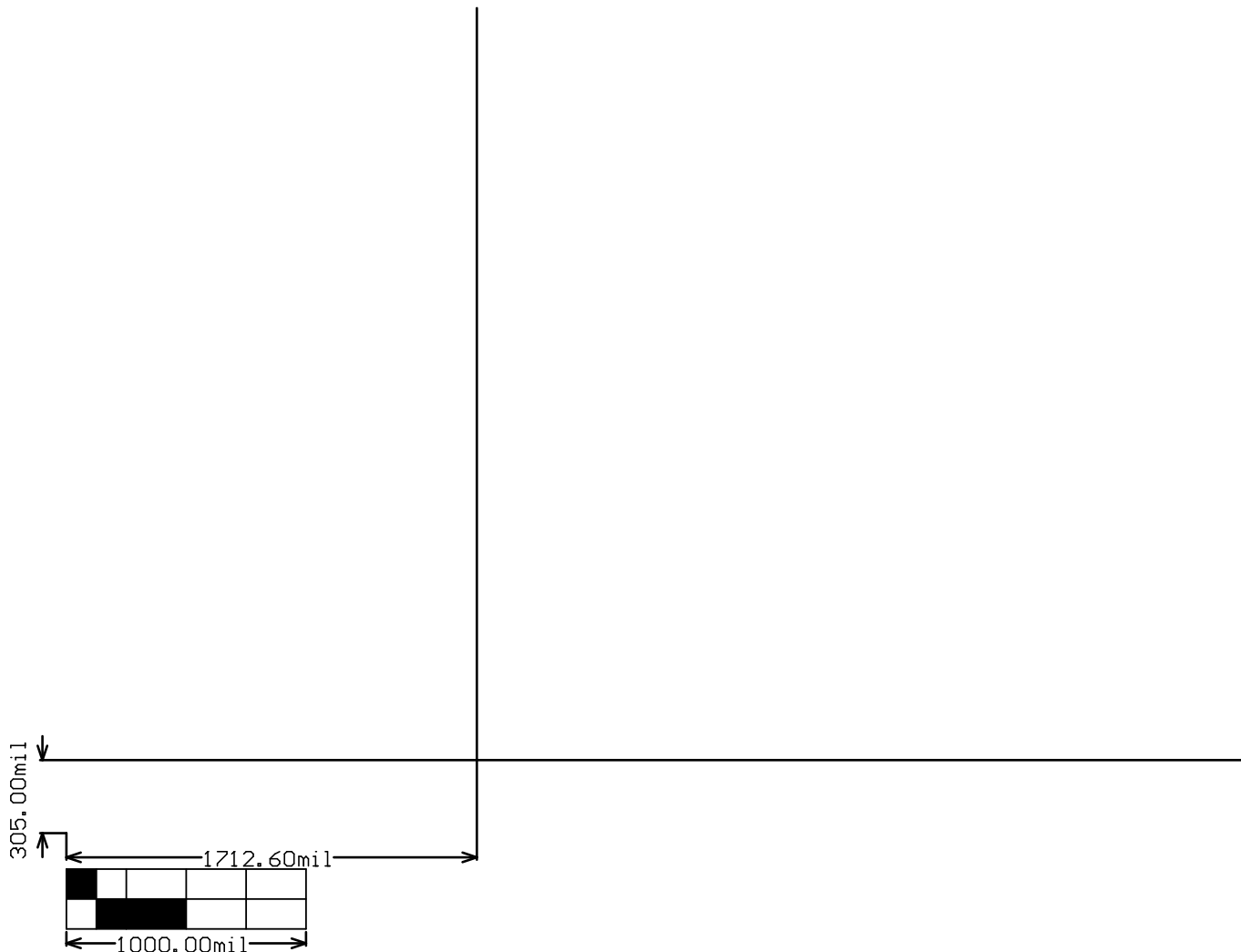


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00776		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/17/2016 15:31:15		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▽	2	70.87mil (1.800mm)	NPTH	Round
⊙	10	16.00mil (0.406mm)	PTH	Round
▽	11	39.37mil (1.000mm)	PTH	Round
☆	10	40.00mil (1.016mm)	PTH	Round
⊙	12	43.31mil (1.100mm)	PTH	Round
⊗	2	45.28mil (1.150mm)	PTH	Round
⊕	5	47.24mil (1.200mm)	PTH	Round
⊗	4	51.18mil (1.300mm)	PTH	Round
⊗	2	55.12mil (1.400mm)	PTH	Round
◇	2	62.99mil (1.600mm)	PTH	Round
B	2	70.87mil (1.800mm)	PTH	Round
⊠	2	106.30mil (2.700mm)	PTH	Round
	64 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00776		
PLOT NAME = Drill Drawing	GENERATED : 11/17/2016 15:31:16		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00776	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00776		
PLOT NAME = Board Dimensions	GENERATED : 11/17/2016 15:31:17		TEXAS INSTRUMENTS

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